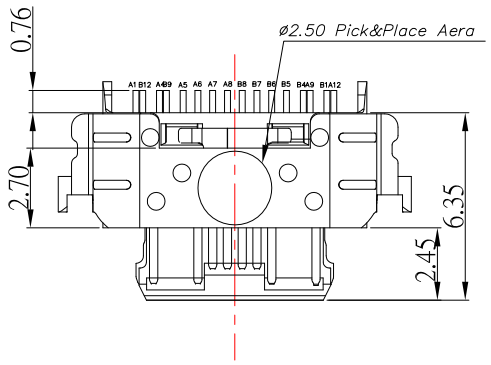
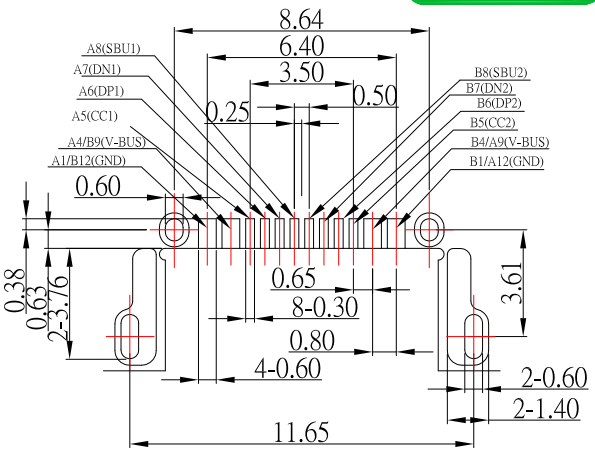
SBC-160M19H-20x-S331

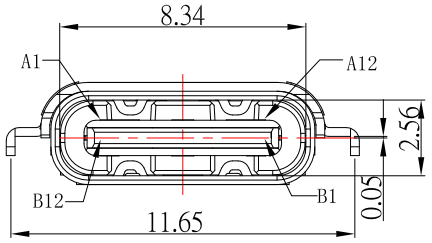
鍍層厚度 :

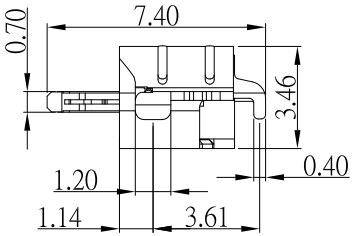
Blank : 1u"
2 : 15u"
3 : 30u"

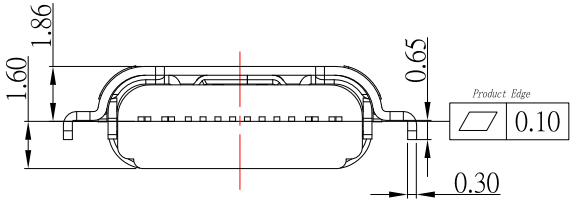


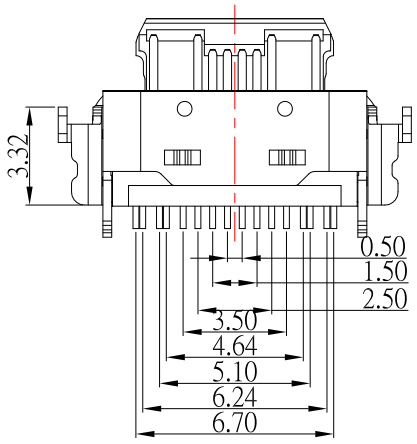


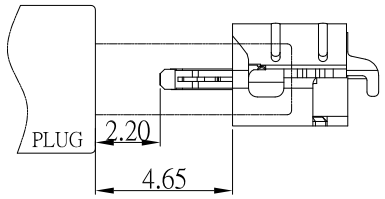
RECOMMENDED P.C.B. LAYOUT











RECEPTACAL
AFTER MATING

SPECIFICATIONS

Electrical:

1.Rating: 5.0 V, 5.0 A

2.Dielectric Withstand Voltage: 100V AC

3.Contact Resistance: 40 mΩ Max

4.Insulation Resistance: 100 MΩ Min

Mechanical:

1.Connector Mate and Unmate Force

1.1 Mate force: 5~20 N

1.2 Unmate force: 8~20 N

Material:

1.Housing: LCP

2.Contact: C18150

3.Shell: SUS

Finish:

1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall

2.Shell: Nickel under Plated surface layer

ITEM NO.	DESCRIPTION	DRAWN	DATE

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2; Above 5 ~ 15 ±0.3; Above 15 ~ 30 ±0.4; Above 30 ~ 50 ±0.5; Angle ±0.3°

3RD. ANGEL'S | UNITS MM

DRAWN BY: Jack Lu	DATE 03/08/23	MAT'L	
CHECKED BY: Jacky Chen	DATE 03/08/23	FINISH	
APPROVED BY: Tony Kao	DATE 03/08/23	SCALE 1 : 1	SHEET NO. 1 of 1

TITLE	CONNECTOR	
MODLE	USB TYPE C 2.0 沉板板上 H1.86mm高導電銅	
DWG NO.	SBC-160M19H-20x-S331	SIZE A4
PART NO.	SBC-160M19H-20x-S331	VER R